



P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C
	29mΩ @ V _{GS} = -4.5V	-6.9A
-20V	39mΩ @ V _{GS} = -2.5V	-5.9A

Features and Benefits

- 0.6mm Profile Ideal for Low Profile Applications
- PCB Footprint of 4mm²
- Low Gate Threshold Voltage
- Low On-Resistance
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at

https://www.diodes.com/products/automotive/automotive-products/.

 This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.

https://www.diodes.com/quality/product-definitions/

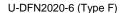
Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}), yet maintain superior switching performance, making it ideal for high efficiency power management applications.

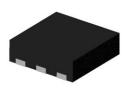
- Battery Management Application
- Power Management Functions
- DC-DC Converters

Mechanical Data

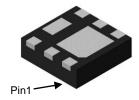
- Case: U-DFN2020-6
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.0065 grams (Approximate)



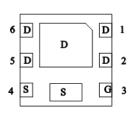




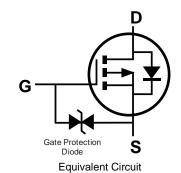
Top View



Bottom View



Pin Out Bottom View



Ordering Information (Note 4)

Part Number	Case	Packaging
DMP2035UFDF-7	U-DFN2020-6 (Type F)	3,000/Tape & Reel
DMP2035UFDF-13	U-DFN2020-6 (Type F)	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information

Site 1



P8 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: H = 2020) M = Month (ex: 9 = September)

Date Code Kev

Year	2016		2020	2021	2022	2023	2024	2025	2026	2027	2028	2029
Code	D		Н		J	K	L	М	N	0	Р	R
Month	lan	Fah	Mar	Δnr	May	lun	lul	Διια	San	Oct	Nov	Dec
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec

Site 2



P8 = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 0 = 2020) W = Week (ex: a = Week 27; z Represents Week 52 and 53) X = Internal Code (ex: U = Monday)

Date Code Kev

Date Code Key												
Year	2016		2020	2021	2022	2023	2024	2025	2026	2027	2028	2029
Code	6		0	1	2	3	4	5	6	7	8	9
147										_	_	
Week	1-26			27-52				53				
Code		A-Z			A-Z a-z							
Internal Code	Sun		Mon		Tue	W	od	Thu		Fri		Sat
	Juli		IVIOII		Tue			IIIu		1 11		Jai
Code	Т		U		V	V	V	X		Υ		Z



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V_{DSS}	-20	V		
Gate-Source Voltage	Vgss	±8	V		
Continuous Drain Current (Note 6) Vos - 4 5V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	Ι _D	-6.9 -5.5	А
Continuous Drain Current (Note 6) V _{GS} = -4.5V	t<10s	$T_A = +25$ °C $T_A = +70$ °C	lo	-8.1 -6.5	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I _{DM}	-40	Α
Continuous Source-Drain Diode Current (Note 6)	Is	-2.5	Α		
Avalanche Current (Note 7) L = 0.1mH	I _{AS}	-21	Α		
Avalanche Energy (Note 7) L = 0.1mH			Eas	23	mJ

Thermal Characteristics ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	D-	0.66	W	
Total Power Dissipation (Note 5)	T _A = +70°C	PD	0.42	VV	
Thermal Begistance, Junction to Ambient (Note 5)	Steady State	Rела	180	°C/W	
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	Көја	135	C/VV	
Total Power Dissipation (Note 6)	$T_A = +25^{\circ}C$	D-	2.03	W	
Total Power Dissipation (Note 6)	$T_A = +70$ °C	P _D	1.31	VV	
Thermal Begistance, Junction to Ambient (Note 6)	Steady State	teady State			
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	R _θ JA	43	°C/W	
Thermal Resistance, Junction to Case (Note 6)	Steady State	$R_{ heta JC}$	17.5		
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	ů	

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

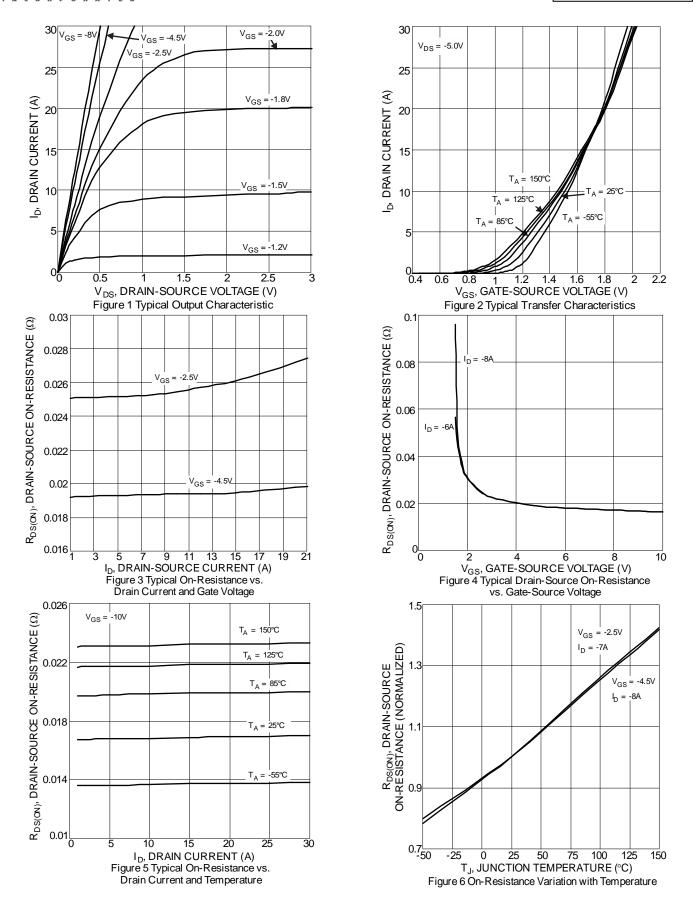
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	-20	_	_	V	$V_{GS} = 0V, I_{D} = -250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	_	_	-1	μΑ	$V_{DS} = -16V, V_{GS} = 0V$	
Gate-Source Leakage	Igss	_	_	±10	μΑ	$V_{GS} = \pm 8V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	Vgs(TH)	-0.4	_	-1.0	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$	
			20	29		$V_{GS} = -4.5V, I_{D} = -6.4A$	
Static Drain-Source On-Resistance	_	_	24	39	mΩ	$V_{GS} = -2.5V$, $I_{D} = -4.8A$	
Static Dialit-Source Off-Resistance	RDS(ON)		31	60	11177	$V_{GS} = -1.8V, I_{D} = -2.5A$	
			40	120		$V_{GS} = -1.5V, I_D = -1.5A$	
Diode Forward Voltage	VsD	_	-0.7	-1.2	V	Vgs = 0V, Is = -1.0A	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	_	1,808	_		T	
Output Capacitance	Coss	_	155	_	pF	$V_{DS} = -15V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	117	_		I = 1.0WII IZ	
Gate Resistance	Rg	_	32	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = -4.5V)	Q_G	_	20.5	_		\\ 40\\ \\ 45\\	
Gate-Source Charge	Qgs	_	2.8	_	nC	$V_{DS} = -10V, V_{GS} = -4.5V,$ $I_{D} = -4.0A$	
Gate-Drain Charge	Q _{GD}	_	4.1	_		ID = -4.0A	
Turn-On Delay Time	t _D (ON)	_	9.1	_			
Turn-On Rise Time	t _R	_	12.3	_	20	$V_{DS} = -10V$, $V_{GS} = -4.5V$,	
Turn-Off Delay Time	t _{D(OFF)}	_	120	_	ns	$R_G = 6\Omega$, $I_D = -1.0A$	
Turn-Off Fall Time	tF	_	54	_			
Reverse Recovery Time	t _{RR}	_	23.1	_	ns	I _F = -1.0A, di/dt = 100A/μs	
Reverse Recovery Charge	Q_{RR}	_	8.3	_	nC	I _F = -1.0A, di/dt = 100A/μs	

5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout. 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate. 7. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_{J} = +25°C. Notes:

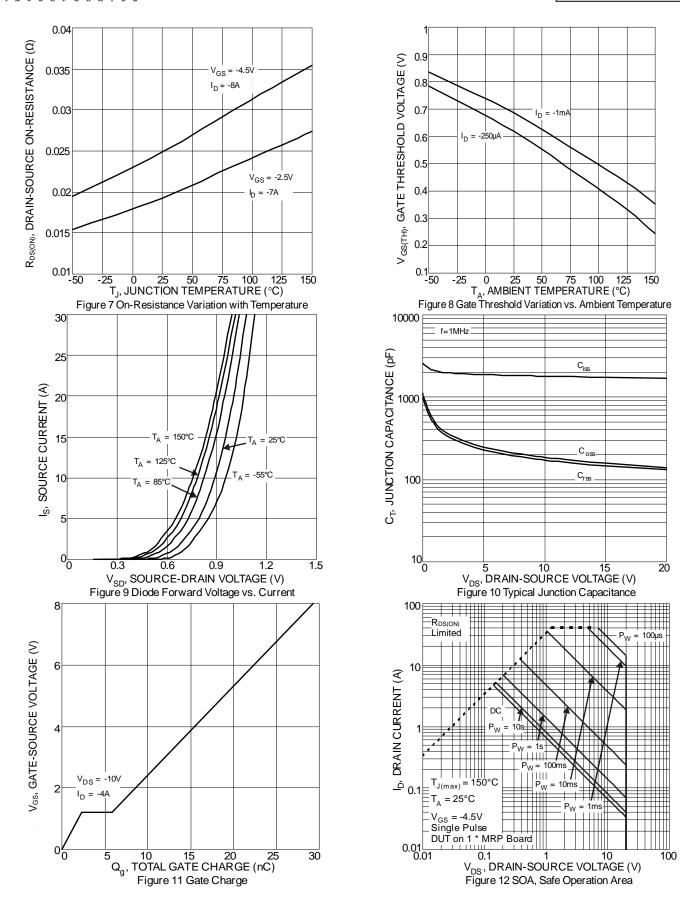
^{8.} Short duration pulse test used to minimize self-heating effect.

^{9.} Guaranteed by design. Not subject to product testing.

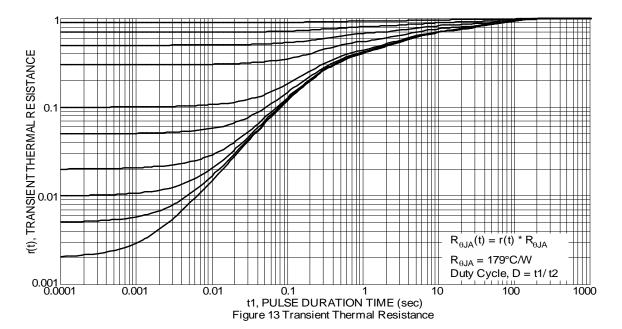










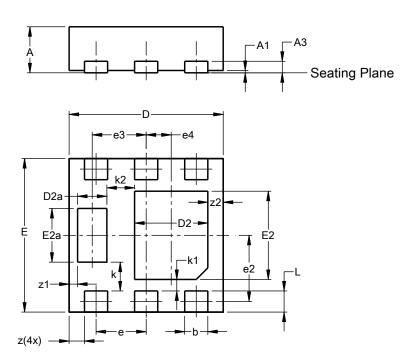




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type F)

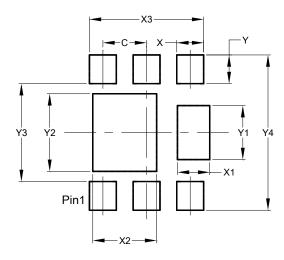


U-DFN2020-6						
	(Тур	oe F)				
Dim	Min	Max	Тур			
Α	0.57	0.63	0.60			
A1	0.00	0.05	0.03			
A3	-	-	0.15			
b	0.25	0.35	0.30			
D	1.95	2.05	2.00			
D2	0.85	1.05	0.95			
D2a	0.33	0.43	0.38			
Е	1.95	2.05	2.00			
E2	1.05	1.25	1.15			
E2a	0.65	0.75	0.70			
е		0.65 BS	C			
e2).863 BS	SC			
e3		0.70 BS	С			
e4	().325 BS	SC			
k		0.37 BS	С			
k1		0.15 BS	С			
k2		0.36 BS	С			
L	0.225	0.325	0.275			
Z		0.20 BS	_			
z 1).110 BS				
z2		0.20 BS	С			
All C)imens	ions in	mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type F)



Dimensions	Value
	(in mm)
С	0.650
Х	0.400
X1	0.480
X2	0.950
Х3	1.700
Υ	0.425
Y1	0.800
Y2	1.150
Y3	1.450
Y4	2.300



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